## Current Flow and Power Dissipation in a Miniature Half Cell

## A Finite Element Analysis (FEA) using flexPDE

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The purpose of this numerical experiment is to learn about the field distribution of potential, current and dissipation in a miniature half cell test jig.

This knowledge helps the researcher to better understand where to place or not place a reference electrode.











Integral= 8.927757e-3

## E Field Magnitude Distribution – Contour Plot



Current Density Distribution – Vector Plot



Current Density Magnitude Distribution – Contour Plot



Integral= -1.561483e-3

Power Density Distribution – Log 10 - Contour Plot



HalfCellTestJig01B: Grid#2 P2 Nodes=801 Cells=378 RMS En= 0.0018 Integral= 1.000008

## Current Density Distribution – On Cell vertical Axis



HalfCellTestJig01B: Grid#2 P2 Nodes=801 Cells=378 RMS En= 0.0018 Integral= 0.862468

Current Density Distribution – Near the Working Electrode

Summary and Conclusions

A finite element model has been developed that allows insight into the nature and magnitude of electric, current and power dissipation fields in a very small half cell test jig

The model could be further developed in many further ways.